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January 2006

FDS8690 N-Channel PowerTrench<sup>®</sup> MOSFET

## FAIRCHILD

SEMICONDUCTOR®

## FDS8690 N-Channel PowerTrench<sup>®</sup> MOSFET

## **30V, 14A, 7.6m**Ω

## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$  and fast switching speed.

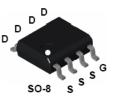
### Applications

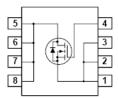
- Notebook CPU power supply
- Synchronous rectifier

#### Features

- Max r<sub>DS(on)</sub> = 7.6mΩ, V<sub>GS</sub> = 10V, I<sub>D</sub> = 14A
- Max r<sub>DS(on)</sub> = 11.4mΩ, V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 11.5A
- High performance trench technology for extremely low r<sub>DS(on)</sub> and fast switching
- Very low gate charge
- High power and current handling capability
- 100% R<sub>G</sub> tested
- RoHS Compliant







## Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise Noted

Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		30	V	
V <sub>GS</sub>	Gate to Source Voltage		±20	V	
	Drain Current -Continuous	(Note 1a)	14	•	
D	-Pulsed		100	— A	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	210	mJ	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5		
		(Note 1b)	1.2	W	
		(Note 1c)	1.0		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to +150	°C	

## **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS8690	FDS8690	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	30			V
∆B <sub>VDSS</sub>	Breakdown Voltage Temperature	$I_D = 250 \mu A$ , referenced to		34.3		mV/°C
ΔTJ		25°C				
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	1.6	3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> =250μA, referenced to 25°C		- 4.5		mV/°C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 14A		6.3	7.6	
r DOVONIN	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 11.5A		8.6	11.4	mΩ
rds(ON)		V <sub>GS</sub> = 10V, I <sub>D</sub> = 14A, T <sub>J</sub> = 125°C		9.0	10.9	11132
Dynamic	Characteristics					
Ciss	Input Capacitance			1260	1680	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz		535	715	pF
	Develope Transfer Conseilence	1 - 111112				
C <sub>rss</sub>	Reverse Transfer Capacitance			80	120	pF
C <sub>rss</sub> R <sub>G</sub>	Gate Resistance	f = 1MHz		80 1.1	120	pF Ω
R <sub>G</sub>	Gate Resistance	f = 1MHz			120	· ·
R <sub>G</sub> Switchinç					120	· ·
R <sub>G</sub> Switching t <sub>d(on)</sub>	Gate Resistance Characteristics (Note 2)	f = 1MHz V <sub>DS</sub> = 15V, I <sub>D</sub> = 1A, V <sub>GS</sub> = 10V, R <sub>GS</sub> = 6Ω		1.1		Ω
R <sub>G</sub> Switching t <sub>d(on)</sub> t <sub>r</sub>	Gate Resistance <b>Characteristics (Note 2)</b> Turn-On Delay Time	V <sub>DS</sub> = 15V, I <sub>D</sub> = 1A,		1.1 8.0	16	Ω ns
R <sub>G</sub> Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Gate Resistance <b>y Characteristics (Note 2)</b> Turn-On Delay Time Rise Time	V <sub>DS</sub> = 15V, I <sub>D</sub> = 1A,		1.1 8.0 1.8	16 10	Ω ns ns
R <sub>G</sub> Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Gate Resistance <b>Characteristics (Note 2)</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time	V <sub>DS</sub> = 15V, I <sub>D</sub> = 1A,		1.1 8.0 1.8 26	16 10 42	Ω ns ns
R <sub>G</sub> Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Gate Resistance <b>Characteristics (Note 2)</b> Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 15V, I_{D} = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V$		1.1 8.0 1.8 26 19	16 10 42 35	Ω ns ns ns ns
R <sub>G</sub> <b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Gate Resistance         g Characteristics (Note 2)         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{DS} = 15V, I_{D} = 1A,$ $V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V$ $I_{D} = 14A$		1.1 8.0 1.8 26 19 18.8	16 10 42 35 27	ns ns ns ns nc
R <sub>G</sub>	Gate Resistance <b>Characteristics (Note 2)</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{DS} = 15V, I_{D} = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V I_{D} = 14A$ $V_{DS} = 15V, V_{GS} = 5V$		1.1 8.0 1.8 26 19 18.8 10	16 10 42 35 27	Ω ns ns ns nC nC
R <sub>G</sub> <b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate Resistance         g Characteristics (Note 2)         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge	$V_{DS} = 15V, I_{D} = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V I_{D} = 14A$ $V_{DS} = 15V, V_{GS} = 5V$		1.1 8.0 1.8 26 19 18.8 10 3.5	16 10 42 35 27	Ω ns ns ns nC nC
R <sub>G</sub> Switching           t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	Gate ResistanceCharacteristics (Note 2)Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeGate to Source Gate ChargeGate to Drain Charge	$V_{DS} = 15V, I_{D} = 1A,$ $V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V$ $I_{D} = 14A$ $V_{DS} = 15V, V_{GS} = 5V$ $I_{D} = 14A$		1.1 8.0 1.8 26 19 18.8 10 3.5	16 10 42 35 27	Ω ns ns ns nC nC
R <sub>G</sub> <b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate Resistance         g Characteristics (Note 2)         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain Charge         urce Diode Characteristics	$V_{DS} = 15V, I_{D} = 1A,$ $V_{GS} = 10V, R_{GS} = 6\Omega$ $V_{DS} = 15V, V_{GS} = 10V$ $I_{D} = 14A$ $V_{DS} = 15V, V_{GS} = 5V$ $I_{D} = 14A$		1.1 8.0 1.8 26 19 18.8 10 3.5 2.9	16 10 42 35 27 14	Ω ns ns ns nC nC nC

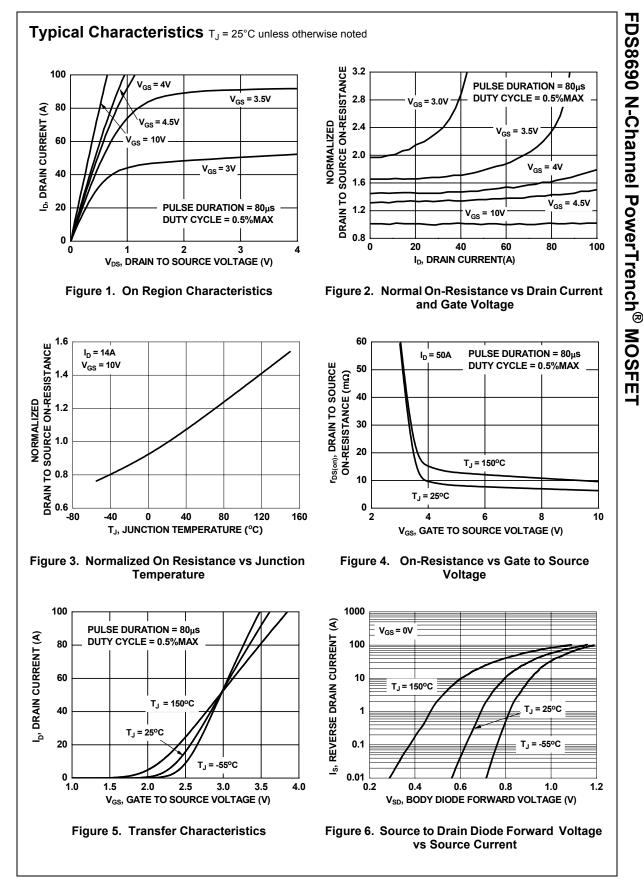


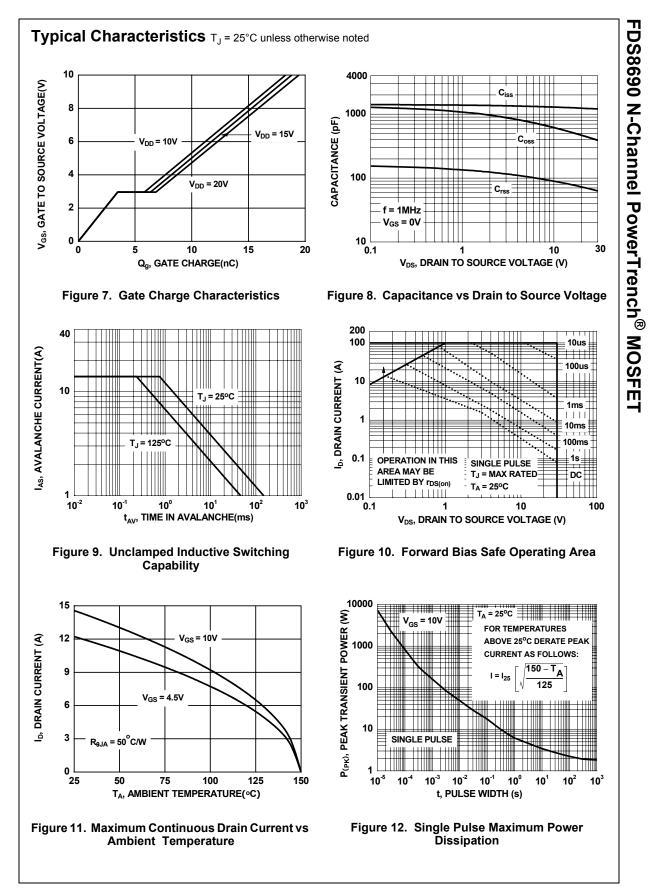
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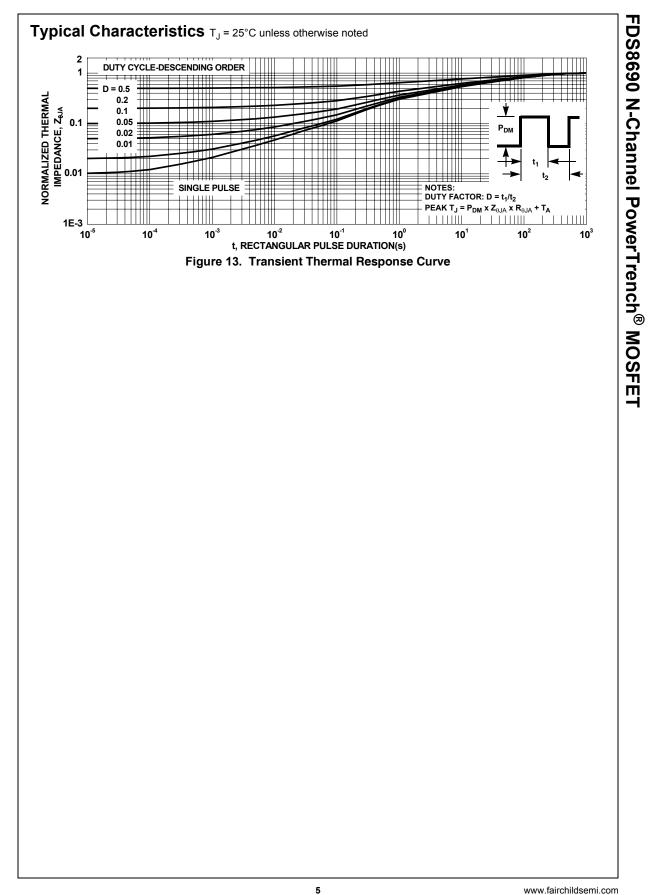
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2. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied. 3. Starting  $T_J = 25^{\circ}C$ , L = 3mH,  $I_{AS} = 11.8A$ ,  $V_{DD} = 24V$ ,  $V_{GS} = 10V$ .

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